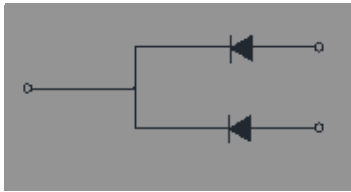


Adopt FRED chip
 Low forward Voltage drop
 Fast reverse recovery time
 High frequency operation
 High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
 Guard ring for enhanced ruggedness and long term reliability

Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.



002 and JESD22-B102
 : As marked

($T_j=25$ Unless otherwise specified)

Device marking code			MURB1060CT
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Surge(Non-repetitive)Forward Current A	I_{Tstg}	M	-55 ~ +175
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Junction Temperature	T_j		-55 ~ +175
Typical Junction capacitance @4V,1MHz	C_j	pF	20



Instantaneous forward voltage drop per diode	V_{FM}	V	$I_{FM}=5.0A @ T_j=25$	-	1.45	1.6	
			$I_{FM}=5.0A @ T_j=150$		1.15	1.3	
DC reverse current at rated DC blocking voltage per diode	I_{RRM1}	uA	$V_{RM}=V_{RRM}$ $T_j=25$	-	-	5.0	
	I_{RRM2}		$V_{RM}=V_{RRM}$ $T_j=150$	-	35	200	
Reverse Recovery Time	T_{rr}	ns	$I_F=0.5A$ $I_{RM}=1A$ $I_{RR}=0.25A$ $T_j=25$	-	25	35	
			$T_j=25$	-	50.8	-	
			$T_j=125$	-	81.8	-	
Peak recovery current	I_{RRM}	A	$T_j=25$	$I_F=5A$ $di/dt=-200A/us$ $V_{RM}=200V$	-	3.06	-
			$T_j=125$		-	5.07	-
Reverse recovery charge	Q_{rr}	nC	$T_j=25$		-	78.88	-
			$T_j=125$		-	280	-

$T_j=25$ Unless otherwise specified

Thermal Resistance	Between junction and case	R J-C	$^{\circ}W$	2.0
Thermal Resistance	Between junction and Air	R J-A	$^{\circ}W$	50

(Example)

MURB1060CT	Approximate 1.43	50	2000	8000	Tube
MURB1060CT	Approximate 1.43	1000	2000	10000	Reel



(Typical)

